



**GP**  
**ELECTRONICS**

**GPM041N03NTF**  
**30V N-Channel MOSFET**

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
30V	3.1mΩ@10V	100A
	4.6mΩ@4.5V	

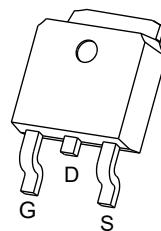
### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

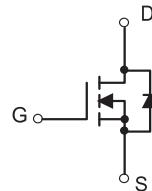
### Application

- Power Switching Application

**TO-252-2L**



**Schematic diagram**



### MARKING:



M041N03N = Device Code

XX = Date Code

Solid Dot = Green Indicator

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	$V_{DS}$	30	V
Gate - Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$I_D$	100	A
Continuous Drain Current <sup>6</sup>	$I_D$	65	A
Continuous Drain Current <sup>6</sup>	$I_D$	25	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	400	A
Single Pulsed Avalanche Current <sup>3</sup>	$I_{AS}$	28	A
Single Pulsed Avalanche Energy <sup>3</sup>	$E_{AS}$	196	mJ
Power Dissipation <sup>5</sup>	$P_D$	84	W
Power Dissipation <sup>6</sup>	$P_D$	2.5	W
Thermal Resistance from Junction to Ambient <sup>6</sup>	$R_{\theta JA}$	50	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	1.5	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

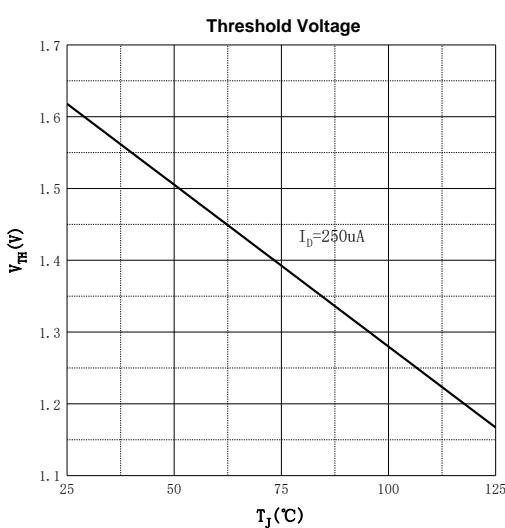
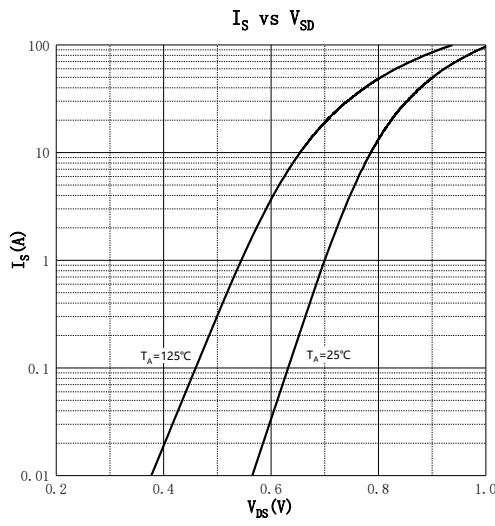
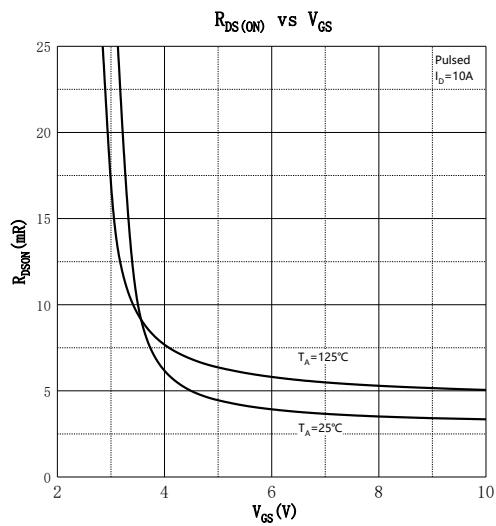
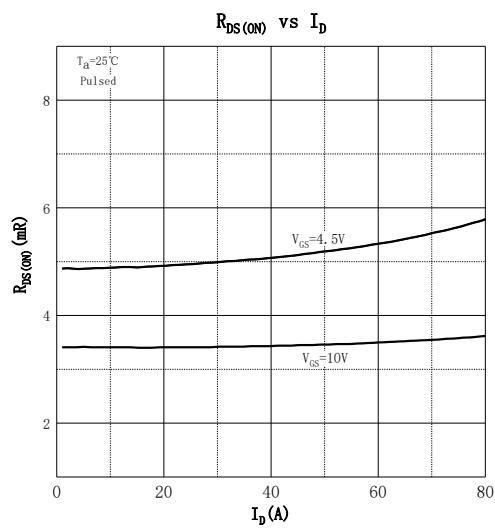
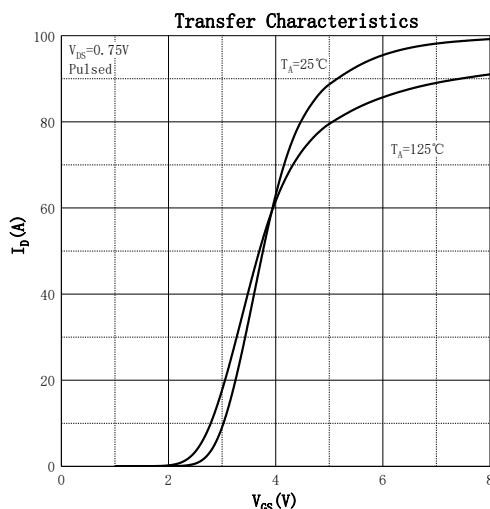
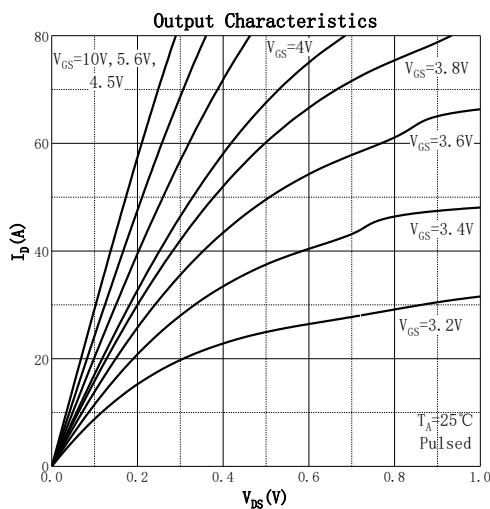
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$  unless otherwise noted)**

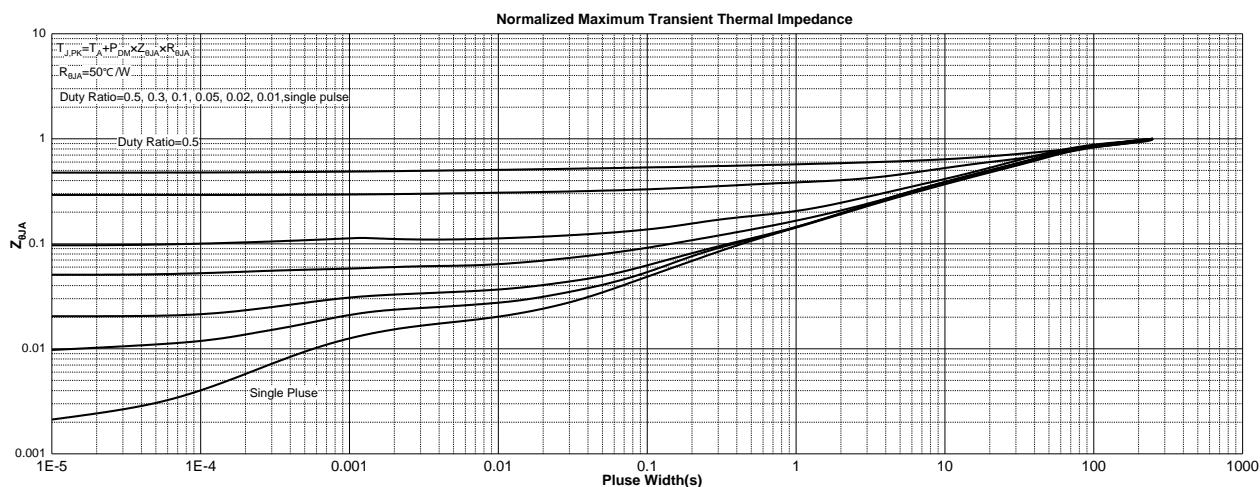
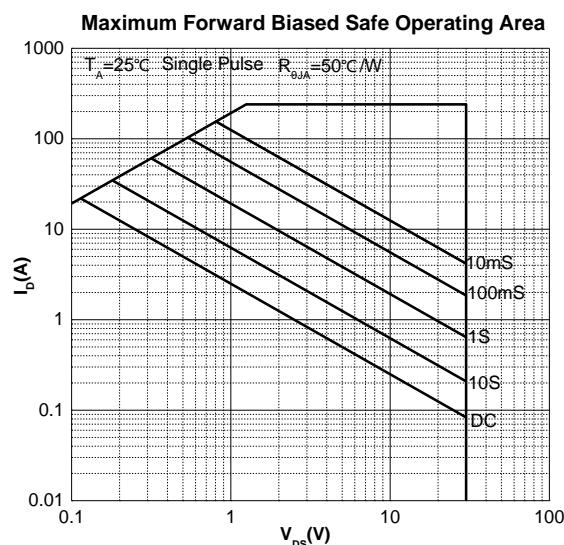
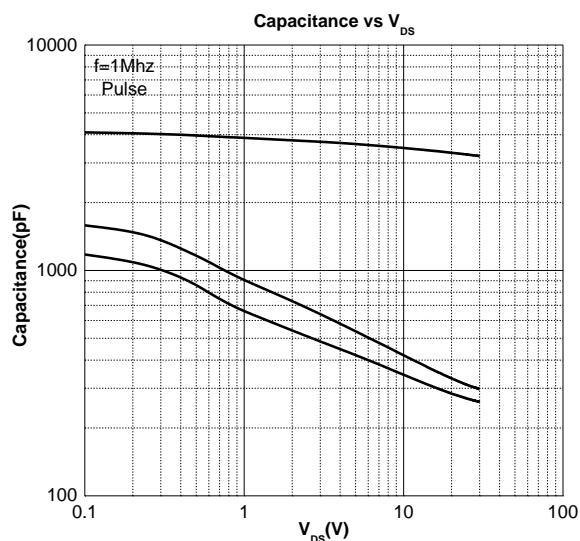
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>On Characteristics<sup>4</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.0	1.5	3.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		3.1	4.1	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 10\text{A}$		4.6	6.5	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 10\text{V}, I_D = 10\text{A}$	10	20		S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		3380		pF
Output Capacitance	$C_{\text{oss}}$			620		
Reverse Transfer Capacitance	$C_{\text{rss}}$			300		
Gate Resistance	$R_g$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1.9		$\Omega$
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 20\text{A}$		33		nC
Gate-source Charge	$Q_{\text{gs}}$			10.6		
Gate-drain Charge	$Q_{\text{gd}}$			20		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 15\text{V}, V_{\text{GS}} = 10\text{V}, R_L = 0.75\Omega$ $R_G = 3\Omega$		13		ns
Turn-on Rise Time	$t_r$			17		
Turn-off Delay Ttime	$t_{\text{d}(\text{off})}$			42		
Turn-off Fall Time	$t_f$			16		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>4</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = 10\text{A}$			1.2	V

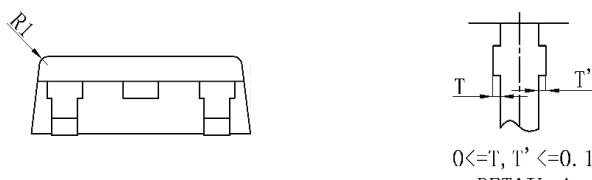
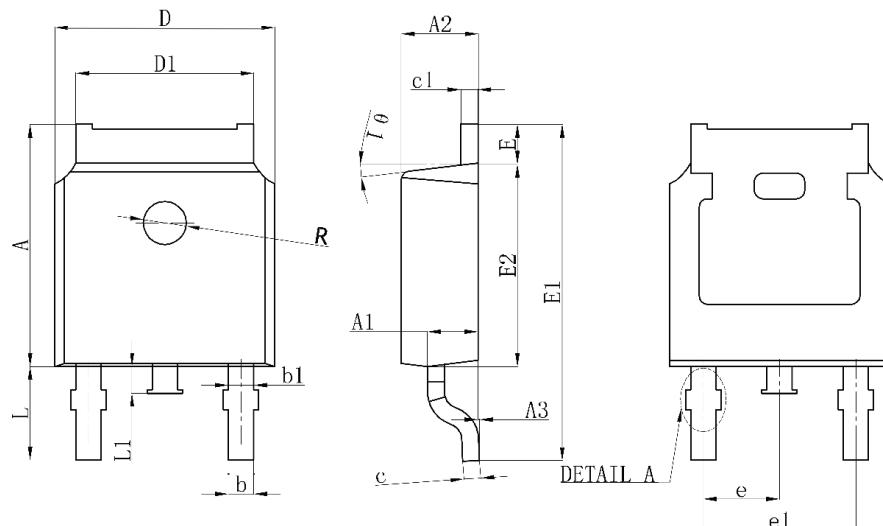
Notes :

- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.E<sub>AS</sub> condition:  $V_{\text{DD}} = 25\text{V}, V_{\text{GS}} = 10\text{V}, L = 0.5\text{mH}, R_G = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$ .
- 4.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 5.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .And device mounted on a large heatsink
- 6.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Characteristics





**TO-252-2L Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	7.050	7.150	0.278	0.281
A1	0.960	1.060	0.038	0.042
A2	2.200	2.400	0.087	0.094
A3	0.000	0.100	0.000	0.004
b	0.760REF		0.030REF	
b1	1.000REF		0.039REF	
c	0.508REF		0.020REF	
c1	0.508REF		0.020REF	
D	6.550	6.650	0.258	0.262
D1	5.100	5.460	0.201	0.215
E	0.950	1.050	0.037	0.041
E1	9.700	10.400	0.382	0.409
E2	6.000	6.200	0.236	0.244
e	2.286BSC		0.090BSC	
e1	4.572REF		0.180REF	
L	2.650	2.950	0.104	0.116
L1	0.700	0.900	0.028	0.035
θ1	7°REF		7°REF	
R	1.300REF		0.051REF	
R1	0.250REF		0.010REF	